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Hiroshi Suenaga and Yoshiyuki Saito

Additional names(s) of conveying party(ies) Yes No

2. Name and address of receiving party(ies):

Name: **Matsushita Electric Industrial Co., Ltd.**

Address: **1006, Oaza Kadoma, Kadoma-shi**

City: **Osaka-fu** State/Prov.: _____

Country: **Japan** ZIP: **571-8501**

Additional name(s) & address(es) Yes No

3. Nature of conveyance:

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Execution Date: **May 7, 2004**

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is:

Patent Application No.	Filing date	B. Patent No.(s)
10/835,824	04/30/2004	

Additional numbers Yes No

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5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **Joseph W. Price**

Registration No. **25,124**

Address: **SNELL & WILMER LLP**
1920 Main Street, Suite 1200

City: **Irvine** State/Prov.: **CA**

Country: **USA** ZIP: **92614**

6. Total number of applications and patents involved: **1**

7. Total fee (37 CFR 3.41):.....\$ **40.00**

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Joseph W. Price
Name of Person Signing

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August 24, 2004
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3

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PATENT
REEL: 015733 FRAME: 0496

ASSIGNMENT

WHEREAS, we, Hiroshi SUENAGA and Yoshiyuki SAITO

citizens of Japan, respectively, have invented certain new and useful improvements in LSI PACKAGE for which we have executed application for Letters Patent of the United States, Serial No. 10/835,824 Filed 04/30/2004

WHEREAS, MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD a corporation of Japan, having a principal place of business at 1006, Oazakadoma, Kadoma-shi, Osaka, 571-8501, Japan is desirous of obtaining the entire right, title and interest in, to and under the said improvements and the said application,

NOW, THEREFORE, in consideration of the sum of One Hundred Yen (100¥) to us in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, we, Hiroshi SUENAGA and Yoshiyuki SAITO have sold, assigned, transferred and set over, unto said MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD., its successors, legal representatives and assigns, the entire right, title and interest in, to and under said improvements, and said application and all divisions, renewals and continuations thereof, and all Letters Patents of the United States, which may be granted thereon and all reissues and extensions thereof, and all priority rights under the International Convention for the Protection of Industrial Property for every country of the Union, and all applications for Letters Patents which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States, and any official of any country or countries foreign to the United States, whose duty it is to issue patents, on applications as aforesaid, to issue all Letters Patents for said improvements to said MATSUSHITA ELECTRIC

INDUSTRIAL CO., LTD., its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD., its successors, legal representatives and assigns, any facts known to us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD., its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

IN TESTIMONY WHEREOF, I have hereunto set my hand this 7 day of

May

, 2004

Hiroshi Suenaga

Hiroshi SUENAGA

IN TESTIMONY WHEREOF, I have hereunto set my hand this 7 day of

May

, 2004

Yoshiyuki Saito

Yoshiyuki SAITO